



## UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE  
 United States Patent and Trademark Office  
 Address: COMMISSIONER FOR PATENTS  
 P.O. Box 1450  
 Alexandria, Virginia 22313-1450  
 www.uspto.gov



Bib Data Sheet

CONFIRMATION NO. 1655

<b>SERIAL NUMBER</b> 10/667,391	<b>FILING DATE</b> 09/23/2003  <b>RULE</b>	<b>CLASS</b> 438	<b>GROUP ART UNIT</b> 2812	<b>ATTORNEY DOCKET NO.</b> M4065.0222/P222-B
------------------------------------	---	---------------------	-------------------------------	---

**APPLICANTS**

Tongbi Jiang, Boise, ID; *SP6*

Alan G. Wood, Boise, ID;

**\*\* CONTINUING DATA \*\*\*\*\***

This application is a DIV of 09/680,473 10/06/2000 PAT 6,647,620 *SP6*  
 which is a DIV of 09/469,630 12/22/1999 PAT 6,413,102

**\*\* FOREIGN APPLICATIONS \*\*\*\*\***

*NONE* *SP6*

**IF REQUIRED, FOREIGN FILING LICENSE GRANTED**  
**\*\* 12/12/2003**

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no 35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance Verified and Acknowledged <i>SP6</i> Examiner's Signature _____ Initials _____	<b>STATE OR COUNTRY ID</b>	<b>SHEETS DRAWING</b> 8	<b>TOTAL CLAIMS</b> 24	<b>INDEPENDENT CLAIMS</b> 4
---	----------------------------	----------------------------	---------------------------	--------------------------------

**ADDRESS**  
 24998  
 DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP  
 2101 L Street, NW  
 Washington , DC  
 20037

**TITLE**  
 Method of making a center bond flip chip semiconductor carrier

<b>FILING FEE RECEIVED</b>	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time )
----------------------------	---	--